

RoHS

## Features

- Logic Level Input
- Input Protection (ESD)
- Thermal shutdown with auto restart
- Green product (RoHS compliant)
- Overload protection
- Short circuit protection
- Overvoltage protection
- Current limitation

Product Summary

| Drain source voltage | $V_{\mathrm{DS}}$ | 42 | V |
| :--- | :--- | :---: | :--- |
| On-state resistance | $R_{\mathrm{DS}(\text { on })}$ | 50 | $\mathrm{~m} \Omega$ |
| Nominal load current | $I_{\mathrm{D}(\text { Nom })}$ | 3.5 | A |
| Clamping energy | $E_{\mathrm{AS}}$ | 3 | J |

- Analog driving possible


## Application

- All kinds of resistive, inductive and capacitive loads in switching or linear applications
- $\mu \mathrm{C}$ compatible power switch for 12 V DC applications
- Replaces electromechanical relays and discrete circuits


## General Description

N channel vertical power FET in Smart SIPMOS ${ }^{\circledR}$ technology. Fully protected by embedded protection functions.


Complete product spectrum and additional information http://www.infineon.com/hitfet

Smart Low Side Power Switch
Power HITFET BTS 134D

Maximum Ratings at $\mathrm{T}_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified

| Parameter | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Drain source voltage | $V_{\text {DS }}$ | 42 | V |
| Supply voltage for full short circuit protection | $V_{\text {bb(SC) }}$ | 42 |  |
| Continuous input voltage ${ }^{1}$ ) | $V_{\text {IN }}$ | -0.2 2) $\ldots+10$ |  |
| Continuous input current ${ }^{2}$ ) $\begin{aligned} & -0.2 \mathrm{~V} \leq V_{\text {IN }} \leq 10 \mathrm{~V} \\ & V_{\text {IN }}<-0.2 \mathrm{~V} \text { or } V_{\text {IN }}>10 \mathrm{~V} \end{aligned}$ | $\iota_{\text {IN }}$ | self limited <br> $\left\|I_{\mathrm{IN}}\right\| \leq 2$ | mA |
| Operating temperature | $T_{j}$ | -40 ... +150 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $T_{\text {stg }}$ | $-55 \ldots+150$ |  |
| Power dissipation ${ }^{5)}$ $T_{\mathrm{C}}=85^{\circ} \mathrm{C}$ <br> $6 \mathrm{~cm}^{2}$ cooling area, $T_{\mathrm{A}}=85^{\circ} \mathrm{C}$ | $P_{\text {tot }}$ | $\begin{aligned} & 43 \\ & 1.1 \end{aligned}$ | W |
| Unclamped single pulse inductive energy ${ }^{2)}$ | $E_{\text {AS }}$ | 3 | $J$ |
| Load dump protection $\left.V_{\text {LoadDump }}{ }^{2) 3}\right)=V_{A}+V_{S}$ $V_{\mathrm{IN}}=0$ and $10 \mathrm{~V}, \mathrm{t}_{\mathrm{d}}=400 \mathrm{~ms}, R_{\mathrm{I}}=2 \Omega$, $R_{\mathrm{L}}=4.5 \Omega, V_{\mathrm{A}}=13.5 \mathrm{~V}$ | $V_{\text {LD }}$ | 65 | V |
| Electrostatic discharge voltage ${ }^{2)}$ (Human Body Model) according to Jedec norm <br> EIA/JESD22-A114-B, Section 4 | $V_{\text {ESD }}$ | 2 | kV |
|  |  |  |  |
|  |  |  |  |

Thermal resistance

| junction - case: | $R_{\text {thJc }}$ | 1.5 | K/W |
| :--- | :--- | :---: | :---: |
| SMD: junction - ambient | $R_{\text {thJA }}$ |  |  |
| @ min. footprint |  | 115 |  |
| $@ 6 \mathrm{~cm}^{2}$ cooling area 4) |  | 55 |  |

${ }^{1}$ For input voltages beyond these limits $\mathrm{I}_{\mathrm{IN}}$ has to be limited.
$2_{\text {not subject to production test, specified by design }}$
${ }^{3} V_{\text {Loaddump }}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839
${ }^{4}$ Device on $50 \mathrm{~mm}^{*} 50 \mathrm{~mm} * 1.5 \mathrm{~mm}$ epoxy PCB FR4 with $6 \mathrm{~cm}^{2}$ (one layer, $70 \mu \mathrm{~m}$ thick) copper area for drain connection. PCB mounted vertical without blown air.
$5_{\text {not subject to production test, calculated by }} \mathrm{R}_{\text {thJA }}$ and $\mathrm{R}_{\mathrm{ds}(\mathrm{on})}$

## Electrical Characteristics

| Parameter at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| Characteristics |  |  |  |  |  |
| Drain source clamp voltage $T_{\mathrm{j}}=-40 \ldots+150, I_{\mathrm{D}}=10 \mathrm{~mA}$ | $V_{\text {DS(AZ) }}$ | 42 | - | 55 | V |
| Off-state drain current $\begin{aligned} & T_{\mathrm{j}}=-40 \ldots+85^{\circ} \mathrm{C}, V_{\mathrm{DS}}=32 \mathrm{~V}, V_{\mathrm{IN}}=0 \mathrm{~V} \\ & T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | IDSS | - | $\begin{gathered} 1.5 \\ 5 \end{gathered}$ | $\begin{gathered} 8 \\ 15 \end{gathered}$ | $\mu \mathrm{A}$ |
| Input threshold voltage $\begin{aligned} & I_{\mathrm{D}}=1.4 \mathrm{~mA}, T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & I_{\mathrm{D}}=1.4 \mathrm{~mA}, T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | $V_{\text {IN(th }}$ | $\begin{aligned} & 1.3 \\ & 0.8 \\ & \hline \end{aligned}$ | 1.7 | $2.2$ | V |
| On state input current | $I_{\text {IN(on) }}$ | - | 10 | 30 | $\mu \mathrm{A}$ |
| On-state resistance $\begin{aligned} & V_{\mathrm{IN}}=5 \mathrm{~V}, I_{\mathrm{D}}=3 \mathrm{~A}, T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & V_{\mathrm{IN}}=5 \mathrm{~V}, I_{\mathrm{D}}=3 \mathrm{~A}, T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | $R_{\text {DS(on) }}$ | - | $\begin{aligned} & 45 \\ & 75 \end{aligned}$ | $\begin{gathered} 60 \\ 100 \end{gathered}$ | $\mathrm{m} \Omega$ |
| On-state resistance $\begin{aligned} & V_{\mathrm{IN}}=10 \mathrm{~V}, I_{\mathrm{D}}=3 \mathrm{~A}, T_{\mathrm{j}}=25^{\circ} \mathrm{C} \\ & V_{\mathrm{IN}}=10 \mathrm{~V}, I_{\mathrm{D}}=3 \mathrm{~A}, T_{\mathrm{j}}=150^{\circ} \mathrm{C} \end{aligned}$ | $R_{\text {DS(on) }}$ | - | $\begin{aligned} & 35 \\ & 65 \end{aligned}$ | $\begin{aligned} & 50 \\ & 90 \end{aligned}$ |  |
| Nominal load current ${ }^{5)}$ $T_{\mathrm{j}}<150^{\circ} \mathrm{C}, V_{\mathrm{IN}}=10 \mathrm{~V}, T_{\mathrm{A}}=85^{\circ} \mathrm{C}, \mathrm{SMD}{ }^{1)}$ | ${ }^{\text {D }}$ (Nom) | 3.5 | 4.6 | - | A |
| Nominal load current ${ }^{5)}$ $V_{\mathrm{IN}}=10 \mathrm{~V}, V_{\mathrm{DS}}=0.5 \mathrm{~V}, T_{\mathrm{C}}=85^{\circ} \mathrm{C}, T_{\mathrm{j}}<150^{\circ} \mathrm{C}$ | $I_{\text {D (ISO) }}$ | 7.1 | 10 | - |  |
| Current limit (active if $\left.V_{D S}>2.5 \mathrm{~V}\right)^{2}$ ) $V_{\mathrm{IN}}=10 \mathrm{~V}, V_{\mathrm{DS}}=12 \mathrm{~V}, t_{\mathrm{m}}=200 \mu \mathrm{~s}$ | $I_{\text {d (lim) }}$ | 18 | 24 | 30 |  |

1@ $6 \mathrm{~cm}^{2}$ cooling area
${ }^{2}$ Device switched on into existing short circuit (see diagram Determination of $\mathrm{D}(\mathrm{lim})$ ). If the device is in on condit and a short circuit occurs, these values might be exceeded for max. $50 \mu \mathrm{~s}$.
$5_{\left.\text {not subject to production test, calculated by } R_{\text {thJA }} \text { and } R_{d s(o n)}\right)}$

Electrical Characteristics

| Parameter <br> at $T_{\mathrm{j}}=25^{\circ} \mathrm{C}$, unless otherwise specified | Symbol | Values |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | min. | typ. | max. |  |
| Dynamic Characteristics |  |  |  |  |  |
| Turn-on time $\quad V_{\text {IN }}$ to $90 \% I_{\mathrm{D}}$ : $R_{\mathrm{L}}=4.7 \Omega, V_{\mathrm{IN}}=0 \text { to } 10 \mathrm{~V}, V_{\mathrm{bb}}=12 \mathrm{~V}$ | $t_{\text {on }}$ | - | 60 | 100 | $\mu \mathrm{s}$ |
| Turn-off time $V_{I N}$ to $10 \% I_{D}$ : $R_{\mathrm{L}}=4.7 \Omega, V_{\mathrm{IN}}=10 \text { to } 0 \mathrm{~V}, \mathrm{~V}_{\mathrm{bb}}=12 \mathrm{~V}$ | $t_{\text {off }}$ | - | 60 | 100 |  |
| Slew rate on $\quad 70$ to $50 \% V_{b b}$ : $R_{\mathrm{L}}=4.7 \Omega, V_{\mathrm{IN}}=0 \text { to } 10 \mathrm{~V}, V_{\mathrm{bb}}=12 \mathrm{~V}$ | $-\mathrm{d} \mathrm{V}_{\text {DS }} / \mathrm{dt}_{\mathrm{on}}$ | - | 0.3 | 1.5 | V/us |
| $\begin{aligned} & \text { Slew rate off } \quad 50 \text { to } 70 \% V_{\mathrm{bb}} \text { : } \\ & R_{\mathrm{L}}=4.7 \Omega, V_{\mathrm{IN}}=10 \text { to } 0 \mathrm{~V}, V_{\mathrm{bb}}=12 \mathrm{~V} \\ & \hline \end{aligned}$ | $\mathrm{dV} \mathrm{DSS}^{/ \mathrm{dt}_{\text {off }}}$ | - | 0.7 | 1.5 |  |

## Protection Functions ${ }^{1)}$

| Thermal overload trip temperature | $T_{\mathrm{it}}$ | 150 | 175 | - | ${ }^{\circ} \mathrm{C}$ |
| :--- | :--- | :---: | :---: | :---: | :---: |
| Thermal hysteresis ${ }^{2)}$ | $\Delta T_{\mathrm{jt}}$ | - | 10 | - | K |
| Input current protection mode <br> $T_{\mathrm{j}}=150^{\circ} \mathrm{C}$ | $I_{\mathrm{N}(\text { Prot })}$ | - | 130 | 300 | $\mu \mathrm{~A}$ |
| Unclamped single pulse inductive energy ${ }^{2)}$ <br> $I_{\mathrm{D}}=3 \mathrm{~A}, T_{\mathrm{j}}=25^{\circ} \mathrm{C}, V_{\mathrm{bb}}=12 \mathrm{~V}$ | $E_{\mathrm{AS}}$ | 3 | - | - | J |

## Inverse Diode

| Inverse diode forward voltage <br> $t_{\mathrm{F}}=15 \mathrm{~A}, t_{\mathrm{m}}=250 \mu \mathrm{~s}, V_{\mathrm{IN}}=0 \mathrm{~V}$, | $V_{\mathrm{SD}}$ | - | 1.0 | 1.5 | V |
| :--- | :--- | :--- | :--- | :--- | :--- |
| $t_{\mathrm{P}}=300 \mu \mathrm{~s}$ |  |  |  |  |  |

[^0]
## Block diagram

## Terms



Input circuit (ESD protection)


Inductive and overvoltage output clamp


Short circuit behaviour




Tid


1 Maximum allowable power dissipation
$P_{\text {tot }}=f\left(T_{C}\right)$ resp.
$P_{\text {tot }}=f\left(T_{A}\right) @ R_{\text {thJA }}=55 \mathrm{~K} / \mathrm{W}$


3 On-state resistance
$R_{\mathrm{ON}}=\mathrm{f}\left(\mathrm{T}_{\mathrm{j}}\right) ; I_{\mathrm{D}}=3 \mathrm{~A} ; V_{\mathrm{IN}}=5 \mathrm{~V}$


2 On-state resistance
$R_{\mathrm{ON}}=\mathrm{f}\left(\mathrm{T}_{\mathrm{j}}\right) ; I_{\mathrm{D}}=3 \mathrm{~A} ; V_{\mathrm{IN}}=10 \mathrm{~V}$


4 Typ. input threshold voltage
$\mathbf{V}_{\mathrm{IN}(\mathrm{th})}=\mathrm{f}\left(\mathrm{T}_{\mathrm{j}}\right) ; I_{\mathrm{D}}=0.7 \mathrm{~mA} ; \mathrm{V}_{\mathrm{DS}}=12 \mathrm{~V}$


5 Typ. transfer characteristics
$\mathrm{I}_{\mathrm{D}}=\mathrm{f}\left(\mathrm{V}_{\mathrm{IN}}\right) ; \mathrm{V}_{\mathrm{DS}}=12 \mathrm{~V} ; \mathrm{T}_{\text {Jstart }}=25^{\circ} \mathrm{C}$


7 Typ. output characteristics
$\mathrm{I}_{\mathrm{D}}=\mathrm{f}\left(\mathrm{V}_{\mathrm{DS}}\right) ; \mathrm{T}_{\text {Jstart }}=25^{\circ} \mathrm{C}$
Parameter: $\mathrm{V}_{\mathrm{IN}}$


6 Typ. short circuit current
$I_{D(\lim )}=f\left(T_{j}\right) ; V_{D S}=12 \mathrm{~V}$
Parameter: $\mathrm{V}_{\mathrm{IN}}$


8 Off-state drain current $I_{\text {DSS }}=f\left(T_{j}\right)$


## 9 Typ. overload current

$I_{D(\lim )}=f(t), V_{b b}=12 \mathrm{~V}$, no heatsink
Parameter: $T_{\text {jstart }}$


10 Typ. transient thermal impedance $Z_{\text {thJA }}=f\left(t_{p}\right) @ 6$ cm$^{2}$ cooling area Parameter: $D=t_{\mathrm{p}} / T$


## 11 Determination of $I_{D(\lim )}$

$I_{D(\lim )}=f(t) ; t_{m}=\mathbf{2 0 0 \mu s}$
Parameter: $T_{\text {Jstart }}$


## 1 Package Outlines



GPT09277

Figure 1 PG-TO252-3-11 (Plastic Dual Small Outline Package) (RoHS-Compliant)

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pbfree finish on leads and suitable for Pb-free soldering according to IPC/JEDEC J-STD-020).

Please specify the package needed (e.g. green package) when placing an order

You can find all of our packages, sorts of packing and others in our Infineon Internet Page "Products": http://www.infineon.com/products.

Smart Low Side Power Switch
Power HITFET BTS 134D

Revision History

## 2 Revision History

| Version | Date | Changes |
| :--- | :--- | :--- |
| Rev. 1.3 | $2006-12-22$ | released automotive green and robust version (BTS) <br> Package parameter (humidity and climatic) removed in Maximum ratings |
| Rev. 1.2 | 2006-12-11 | AEC icon added <br> RoHS icon added <br> Green product (RoHS-compliant) added to the feature list <br> Package information updated to green <br> Green explanation added |
| Rev. 1.1 | $2006-08-08$ | released non automotive green version (ITS) |
| Rev. 1.0 | $2004-03-05$ | released production version |
|  |  |  |
|  |  |  |
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|  |  |  |

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[^0]:    ${ }^{1}$ Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation
    $2_{\text {not subject to production test, specified by design }}$

